CDR on CEPC ECal

Tao Hu IHEP

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Global R&D of Imaging Calorimeters



Readout cell size: 144 - 9 cm² \rightarrow 4.5 cm² \rightarrow 1 cm² \rightarrow 0.25 cm² \rightarrow 0.13 cm² \rightarrow 2.5x10-5 cm²Technology:Scintillator +
SiPM/MPPCScintillator +
SiPM/MPPCGas detectors Silicon
SiliconSilicon (MAPS)

From Manqi

Feasibility & Optimized Parameters

Feasibility analysis: TPC and Passive Cooling Calorimeter is valid for CEPC

| | CEPC_v1 (~ ILD) | Optimized (Preliminary) | Comments |
|----------------|--------------------|----------------------------|---|
| Track Radius | 1.8 m | >= 1.8 m | Requested by Br(H->di muon) measurement |
| B Field | 3.5 T | 3 T | Requested by MDI |
| ToF | - | 50 ps | Requested by pi-Kaon separation at Z pole |
| ECAL Thickness | 84 mm | 84(90) mm | 84 mm is optimized on Br(H->di photon) at 250 GeV; 90mm for bhabha event at 350 GeV |
| ECAL Cell Size | 5 mm | 10 – 20 mm | Passive cooling request ~ 20 mm. 10 mm should be highly appreciated for EW measurements – need further evaluation |
| ECAL NLayer | 30 | 20 – 30 | Depends on the Silicon Sensor thickness |
| HCAL Thickness | 1.3 m | 1 m | - |
| HCAL NLayer | 48 | 40 | Optimized on Higgs event at 250 GeV; Margin might be reserved for 350 GeV. |

Structure of the ECAL



Silicon Sensors

high resistivity silicon pin diodes

Stability:

completely depleted pin-diode 's response to MIP mostly defined by the thickness of the sensor, with a very low dependence on temperature, radiation, humidity, ...

Uniformity

the control of the thickness over large batches can ensures a uniformity of response

Flexibility

the dimension and geometry of the cells are defined by the readout pad on the PCB

High Signal-to-Noise ratio
 ~ 80 electron-hole pairs



Power and Cooling

- A ILD-like Calorimeter should work for CEPC but power pulsing
- a reduced number of channels (20x20 mm) may only need passive cooling

Active cooling (CO₂)







Scintillator-W option

A super-layer (7mm) is made of

- > tungsten plate (3 mm thick)
- 5x45 mm² scintillator strips (2 mm thick)
- a readout/service layer (2 mm thick)



Light output and uniformity





- Rough Reflective surfaces and suitable coupling mode can improve uniformity of light output along scintillator strip.
- Further optimization is under study

SiPM dynamic range



 The range of energy deposition in scintillator module is quite large.

 10k pixel number SiPM is required for big dynamic range (1 MIP>10 p.e.)

 $5mm \times 45mm \times 2mm$

SiPM response test

- When the recovery time of each pixel of SiPM is faster than the duration of one event, some pixels will contribute to an signal more than once. It makes the effective response pixels larger than the real number of pixels, and extend the dynamic range of SiPM
- · The effective response pixels can be described by following formula

$$N_{fire} = N_{eff} (1 - e^{-\epsilon N_{in}/N_{eff}})$$

N_{fire}: the number of fired pixels, N_{eff}: the effective pixel number of pixels

 $\epsilon\,$: photon detection efficiency, $\,\,N_{in}$: the number of incident photons.



Electronics



 Based on SPIROC2b

 dynamic range 100fC-300pC gotten

